KEY PARAMETERS

 $\mathbf{V}_{\mathtt{DRM}}$

I_{T(RMS)}

dV/dt

dl/dt

ta

DS4272-2.2

2000V

400A

4000A

200V/us

500A/μs

50μ**s**

TF440..CFAST SWITCHING THYRISTOR

APPLICATIONS

- High Power Inverters And Choppers.
- UPS.
- Railway Traction.
- Induction Heating.
- AC Motor Drives.
- Cycloconverters.

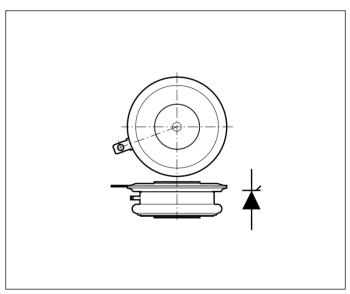
FEATURES

- Double Side Cooling.
- High Surge Capability.
- High Voltage.

VOLTAGE RATINGS

Type Number	Repetitive Peak Voltages V _{DRM} V _{RRM}	Conditions
TF440 20C	2000	$V_{RSM} = V_{RRM} + 100V$
TF440 18C	1800	TOW TAXW
TF440 16C	1600	$I_{DRM} = I_{RRM} = 25 \text{mA}$
TF440 14C	1400	2
		at V_{RRM} or V_{DRM} & T_{vj}

Lower voltage grades available.



Outline type code: MU86. Turn to page 12 for further information.

CURRENT RATINGS

Symbol	Parameter	Conditions	Max.	Units
I _{T(AV)}	Mean on-state current	Half sinewave, 50Hz, T _{case} = 80°C	255	А
I _{T(RMS)}	RMS value	Half sinewave, 50Hz, T _{case} = 80°C	400	А

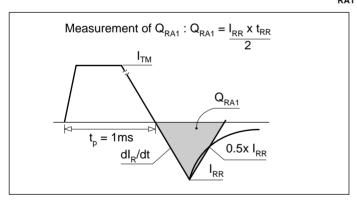
SURGE RATINGS

Symbol	Parameter	Conditions	Max.	Units
I _{TSM}	Surge (non-repetitive) on-state current	10ms half sine; $V_R = 0\% V_{RRM}$, $T_j = 125$ °C	4.0	kA
l ² t	I ² t for fusing	10ms half sine; $V_R = 0\% V_{RRM}$, $T_j = 125$ °C	80.0 x 10 ³	A ² s

THERMAL AND MECHANICAL DATA

Symbol	Parameter	Conditions		Min.	Max.	Units
R _{th(j-c)}	Thermal resistance - junction to case	Double side cooled	dc	-	0.07	°C/W
		Single side cooled	Anode dc	-	0.133	°C/W
			Cathode dc	-	0.154	°C/W
R _{th(c-h)}	Thermal resistance - case to heatsink	Clamping force 5.0kN with mounting compound	Double side	-	0.02	°C/W
			Single side	-	0.04	°C/W
$T_{v_{j}}$	Virtual junction temperature	On-state (conducting)		-	125	°C
		Reverse (blocking)		-	125	°C
T _{stg}	Storage temperature range			-40	150	°C
-	Clamping force			4.75	5.25	kN

MEASUREMENT OF RECOVERED CHARGE - \mathbf{Q}_{RA1}



DYNAMIC CHARACTERISTICS

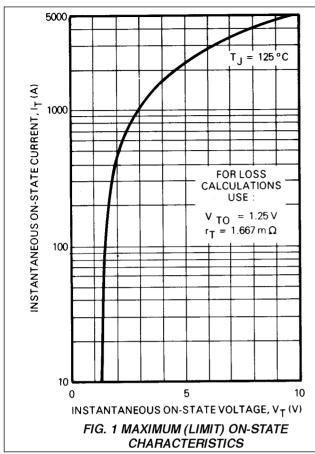
Symbol	Parameter	Conditions		Min.	Max.	Units
V _{TM}	Maximum on-state voltage	At 450A peak, T _{case} = 25°C		-	2.0	V
I _{RRM} /I _{DRM}	Peak reverse and off-state current	At V_{RRM}/V_{DRM} , $T_{case} = 125^{\circ}C$	At V_{RRM}/V_{DRM} , $T_{case} = 125^{\circ}C$		25	mA
dV/dt	Maximum linear rate of rise of off-state voltage	Linear to 60% V_{DRM} $T_j = 125^{\circ}C$,	Linear to 60% V_{DRM} T_j = 125°C, Gate open circuit		200	V/μs
-11/-14		Gate source 20V, 20Ω	Repetitive 50Hz	-	500	A/μs
dl/dt	Rate of rise of on-state current	t _r ≤ 0.5μs, T _j = 125°C	Non-repetitive	-	800	A/μs
V _{T(TO)}	Threshold voltage	At T _{vj} = 125°C		-	1.25	V
r _T	On-state slope resistance	At T _{vj} = 125°C		-	1.66	mΩ
t _{gd}	Delay time	$T_{j} = 25^{\circ}C, I_{T} = 100A,$ $V_{D} = 50V, I_{G} = 1A,$ $dI/dt = 50A/\mu s, dI_{G}/dt = 1A/\mu s$		-	3*	μs
t _{(ON)TOT}	Total turn-on time			-	1.5*	μs
I _H	Holding current	$T_{j} = 25^{\circ}C, I_{TM} = 1A, V_{D} = 12V$		-	70	mA
t _q	Turn-off time	$\begin{aligned} & \textbf{T}_{j} = 125^{\circ}\textbf{C}, \ \textbf{I}_{T} = 200\textbf{A}, \ \textbf{V}_{R} = 50\textbf{V}, \\ & \textbf{dV/dt} = 200\textbf{V/}\mu\text{s} \ (\text{Linear to 60\% V}_{DRM}), \\ & \textbf{dI}_{R}/\text{dt} = 30\textbf{A/}\mu\text{s}, \ \text{Gate open circuit} \end{aligned}, \ \textbf{t}_{q} \ \text{code: C}$		-	50	μs

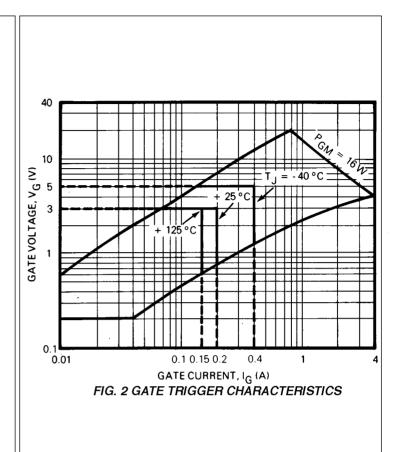
^{*}Typical value.

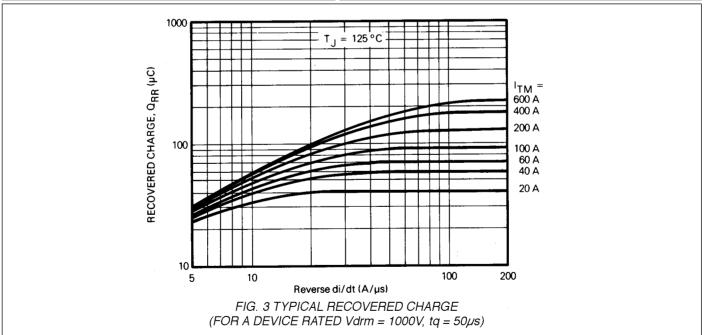
GATE TRIGGER CHARACTERISTICS AND RATINGS

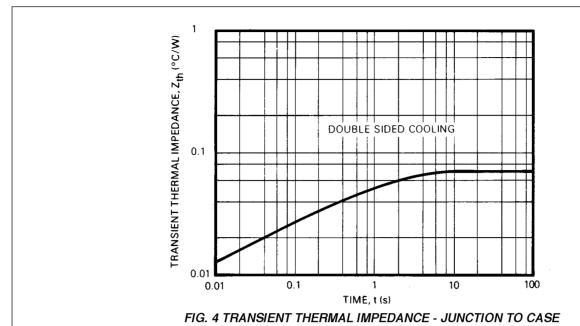
Symbol	Parameter	Conditions		Max.	Units
V _{GT}	Gate trigger voltage	$V_{DRM} = 12V$, $T_{case} = 25$ °C, $R_{L} = 6\Omega$	-	3.0	V
I _{GT}	Gate trigger current	$V_{DRM} = 12V, T_{case} = 25^{\circ}C, R_{L} = 6\Omega$	-	200	mA
V _{GD}	Gate non-trigger voltage	At V_{DRM} $T_{case} = 125^{\circ}C$, $R_{L} = 1k\Omega$	-	0.2	V
V _{RGM}	Peak reverse gate voltage		-	5.0	V
I _{FGM}	Peak forward gate current	Anode positive with respect to cathode	-	4	А
P _{GM}	Peak gate power		-	16	W
P _{G(AV)}	Mean gate power		-	3	W

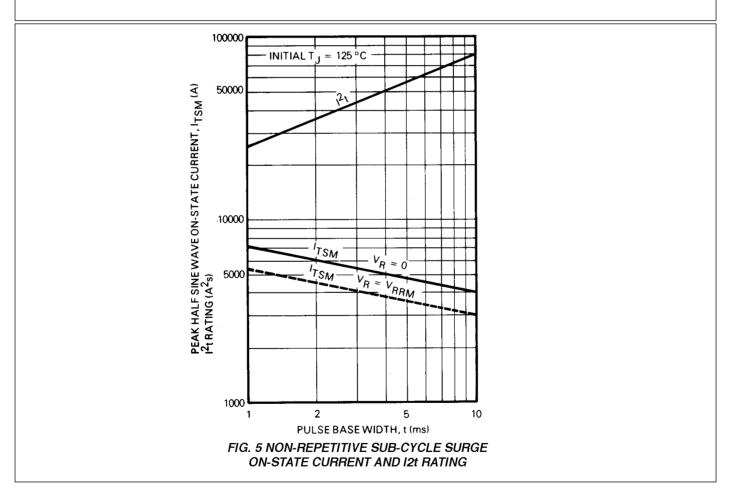
CURVES

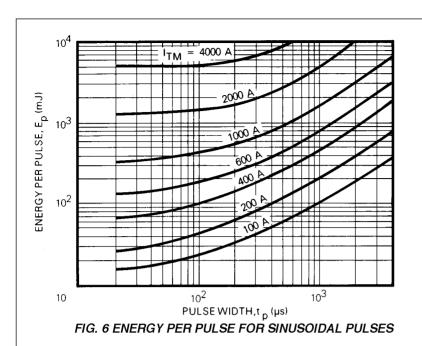






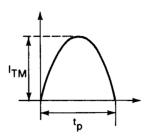


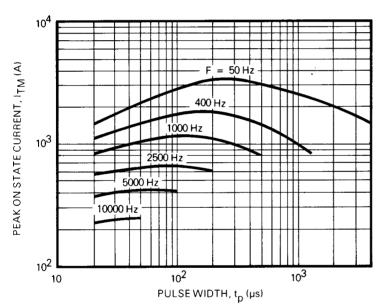




NOTES:

- 1. $V_D \le 600V$. 2. $V_R \le 10V$. 3. R.C Snubber, $C = 0.22\mu F$, $R = 4.7\Omega$





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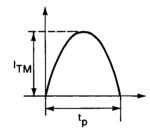


FIG. 7 MAXIMUM ALLOWABLE PEAK ON-STATE CURRENT vs PULSE WIDTH FOR Tc = 65°C

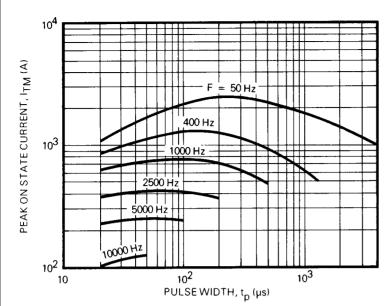
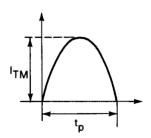
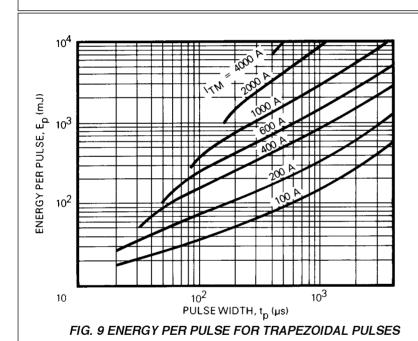


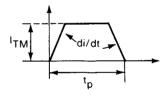
FIG. 8 MAXIMUM ALLOWABLE PEAK ON-STATE CURRENT vs PULSE WIDTH FOR Tc = 90°C

- 1. $V_D \le 600V$. 2. $V_R \le 10V$. 3. R.C Snubber, $C = 0.22\mu F$, $R = 4.7\Omega$





- 1. $dI/dt = 25A/\mu s$
- 2. $V_D \le 600V$. 3. $V_R \le 10V$.
- 4. R.C Snubber, $C = 0.22\mu F$, $R = 4.7\Omega$



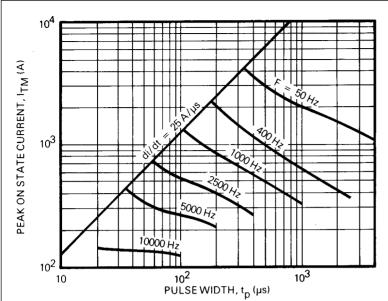
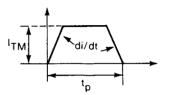


FIG. 10 MAXIMUM ALLOWABLE PEAK ON-STATE CURRENT vs PULSE WIDTH FOR Tc = 65°C

- 1. $dI/dt = 25A/\mu s$

- 2. $V_D \le 600V$. 3. $V_R \le 10V$. 4. R.C Snubber, $C = 0.22\mu F$, $R = 4.7\Omega$



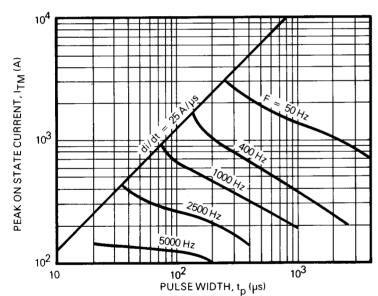
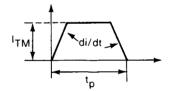
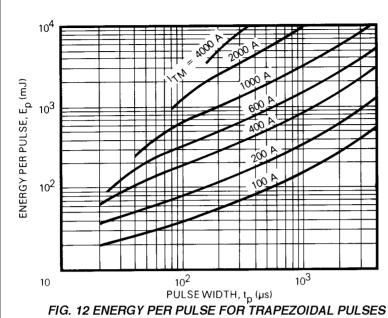


FIG. 11 MAXIMUM ALLOWABLE PEAK ON-STATE CURRENT vs PULSE WIDTH FOR Tc = 90°C

- 1. $dI/dt = 25A/\mu s$

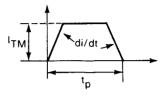
- 2. $V_D \le 600V$. 3. $V_R \le 10V$. 4. R.C Snubber, $C = 0.22\mu F$, $R = 4.7\Omega$





- 1. $dI/dt = 50A/\mu s$

- 2. $V_D \le 600V$. 3. $V_R \le 10V$. 4. R.C Snubber, $C = 0.22\mu F$, $R = 4.7\Omega$



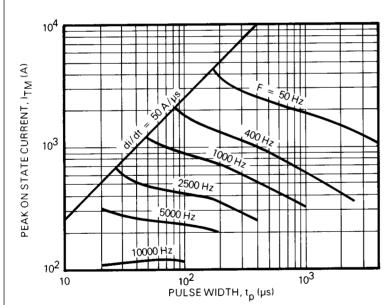
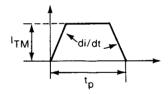


FIG. 13 MAXIMUM ALLOWABLE PEAK ON-STATE CURRENT vs PULSE WIDTH FOR Tc = 65°C

- 1. $dI/dt = 50A/\mu s$

- 2. $V_D \le 600V$. 3. $V_R \le 10V$. 4. R.C Snubber, $C = 0.22\mu F$, $R = 4.7\Omega$



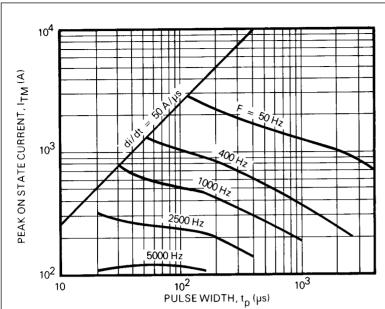
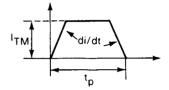


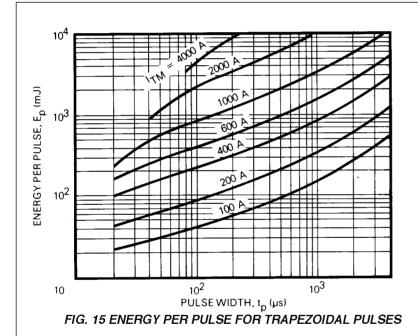
FIG. 14 MAXIMUM ALLOWABLE PEAK ON-STATE CURRENT vs PULSE WIDTH FOR Tc = 90°C

NOTES:

- 1. $dI/dt = 50A/\mu s$

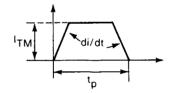
- 2. $V_D \le 600V$. 3. $V_R \le 10V$. 4. R.C Snubber, $C = 0.22\mu F$, $R = 4.7\Omega$





- 1. $dI/dt = 100A/\mu s$

- 2. $V_D \le 600V$. 3. $V_R \le 10V$. 4. R.C Snubber, $C = 0.22\mu F$, $R = 4.7\Omega$



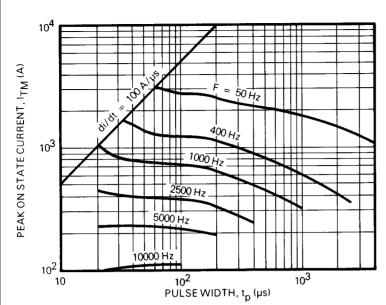
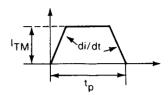


FIG. 16 MAXIMUM ALLOWABLE PEAK ON-STATE CURRENT vs PULSE WIDTH FOR Tc = 65°C

- 1. $dI/dt = 100A/\mu s$

- 2. $V_D \le 600V$. 3. $V_R \le 10V$. 4. R.C Snubber, $C = 0.22\mu F$, $R = 4.7\Omega$



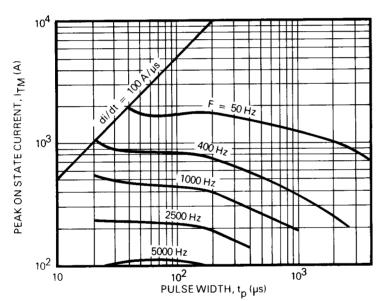
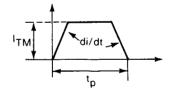


FIG. 17 MAXIMUM ALLOWABLE PEAK ON-STATE CURRENT vs PULSE WIDTH FOR Tc = 90°C

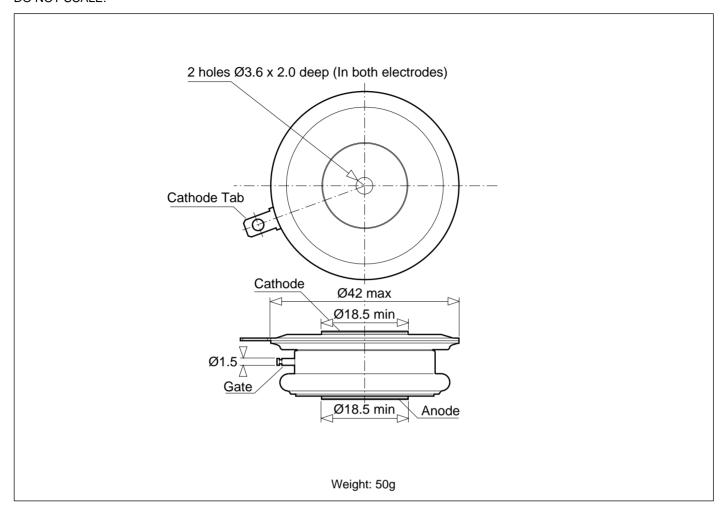
- 1. $dI/dt = 100A/\mu s$

- 2. $V_D \le 600V$. 3. $V_R \le 10V$. 4. R.C Snubber, $C = 0.22\mu F$, $R = 4.7\Omega$



PACKAGE DETAILS - MU86

For further package information, please contact your local Customer Service Centre. All dimensions in mm, unless stated otherwise. DO NOT SCALE.





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